

Docket No.: 27-013

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

<i>In re</i> Application of:	Tie Wang, et al.	:	Confirmation No.:	2840
Serial No.:	10/766,746	:	Art Unit:	2813
Filed:	1/27/2004	:	Examiner:	Jennifer M. Dolan
For:	STRIP-FABRICATED FLIP CHIP IN PACKAGE AND FLIP CHIP IN SYSTEM HEAT SPREADER ASSEMBLIES AND FABRICATION METHODS THEREFOR			

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*Amend - OK - to
enter - gmb
5/25/06*

**AMENDMENT AND RESPONSE AFTER FINAL REJECTION
UNDER 37 C.F.R. §1.116**

Madam:

The following Amendment and Remarks are submitted under 37 C.F.R. §1.116 in response to the Final Office Action mailed March 15, 2006, following the amendment format set forth under 37 CFR §1.121. After this introductory section, there are Amendments to the Claims, and then Remarks, each starting on a separate page.

Amendments to the Claims consist of amendments for claims 1, 6, 11, and 16, which are incorporated in a complete listing of the claims.

Reconsideration of the rejections is respectfully requested.